

# Ku Band 2 Watt Packaged Amplifier

# TGA2510-EPU-SG



Preliminary Measured Performance Bias Conditions: Vd=7.5V Id=650mA



### Key Features and Performance

- 33.5 dBm Midband Psat
- 25 dB Nominal Gain
- 7 dB Typical Input Return Loss
- 10 dB Typical Output Return Loss
- 12.5 17 GHz Frequency Range
- Directional Power Detector with Reference
- 0.25µm pHEMT 3MI Technology
- Bias Conditions: 7.5V, 650mA
- Package Dimensions:
  9.4 x 6.4 x 1.8 mm
  (0.370 x 0.250 x 0.071 inches)

1

### **Primary Applications**

- VSAT
- Point to Point



### TGA2510-EPU-SG

2

### TABLE I MAXIMUM RATINGS

Symbol	Parameter	Value	Notes
VD	Drain Voltage	8 V	<u>1/ 2</u> /
$V_{G}$	Gate Voltage Range	-5V to 0V	<u>1</u> /
I <sub>D</sub>	Drain Supply Current (Quiescent)	1300 mA	<u>1/ 2</u> /
<sub>G</sub>	Gate Supply Current	18 mA	<u>1</u> /
P <sub>IN</sub>	Input Continuous Wave Power	24 dBm	<u>1/ 2</u> /
PD	Power Dissipation	6.15 W	<u>1/ 2/ 3/</u>
Т <sub>СН</sub>	Operating Channel Temperature	150 <sup>0</sup> C	<u>4</u> /
Τ <sub>M</sub>	Mounting Temperature (30 Seconds)	320 <sup>0</sup> C	
T <sub>STG</sub>	Storage Temperature	-65 to 150 <sup>0</sup> C	

- 1/ These ratings represent the maximum operable values for this device
- $\underline{2}$ / Combinations of supply voltage, supply current, input power, and output power shall not exceed P<sub>D</sub> at a package base temperature of 70°C
- **<u>3</u>**/ When operated at this bias condition with a baseplate temperature of 70°C, the MTTF is reduced to 1.0E+6 hours
- **<u>4</u>**/ Junction operating temperature will directly affect the device median time to failure (MTTF). For maximum life, it is recommended that junction temperatures be maintained at the lowest possible levels.

### TABLE II THERMAL INFORMATION

Parameter	Test Conditions	Т <sub>сн</sub> (°С)	R <sub>⊛JC</sub> (°C/W)	MTTF (hrs)
R <sub>⊌JC</sub> Thermal Resistance (Channel to Backside of Package)	$V_D = 7.5V$ $I_D = 650mA$ $P_{DISS} = 4.88W$ $T_{BASE} = 70^{\circ}C$	132.3	12.8	4.8E+6



TGA2510-EPU-SG

3

### TABLE III RF CHARACTERIZATION TABLE $(T_A = 25^{\circ}C, Nominal)$ $(Vd = 7.5V, Id = 650mA \pm 5\%)$

Symbol	Parameter	Test Conditions	Тур	Units	Notes
Gain	Small Signal Gain	F = 12.5 – 16 GHz	25	dB	
IRL	Input Return Loss	F = 12.5 – 16 GHz	7	dB	
ORL	Output Return Loss	F = 12.5 – 16 GHz	10	dB	
PWR	Output Power @ Pin = +14dBm	F = 12.5 – 16 GHz	33.5	dBm	
PAE	Power Added Efficiency @ Pin = +14dBm	F = 12.5 – 16 GHz	29	%	

Note: Table III Lists the RF Characteristics of typical devices as determined by fixtured measurements.



4







5







TGA2510-EPU-SG

6





7







TGA2510-EPU-SG

8



# Package Pinout Diagram

# Package Assembly Diagram



#### GaAs MMIC devices are susceptible to damage from Electrostatic Discharge. Proper precautions should be observed during handling, assembly and test.



# **Advance Product Information** October 30, 2003 TGA2510-EPU-SG



**Mechanical Drawing** 

Dimensions in inches

9



10

# **Recommended PWB Land Pattern**





TGA2510-EPU-SG

11

